

## **High Performance Differential MEMS Oscillators**

#### Features

- Very Low RMS Phase Jitter: <650 fs (typ.)
- High Stability: ±20 ppm, ±25 ppm, ±50 ppm
- Wide Temperature Range:
  - Automotive: -40°C to +125°C (DSC12x3 LVDS Only)
  - Extended Industrial: -40°C to +105°C
  - Industrial: -40°C to +85°C
  - Commercial: –20°C to +70°C
- Supports LVPECL, LVDS, or HCSL Differential Outputs
- Wide Frequency Range: 2.5 MHz to 450 MHz
- Small Industry-Standard Footprints
  - 2.5 mm x 2.0 mm
  - 3.2 mm x 2.5 mm
  - 5.0 mm x 3.2 mm
  - 7.0 mm x 5.0 mm
- Excellent Shock and Vibration Immunity
  - Qualified to MIL-STD-883
- · High Reliability
- 20x Better MTF than Quartz Oscillators
- Supply Range of 2.25V to 3.63V
- Standby, Frequency Select, and Output Enable Functions
- Lead-Free and RoHS-Compliant

#### Applications

- Storage Area Networks
- Passive Optical Networks
- 10/100G Ethernet
- HD/SD/SDI Video and Surveillance
- PCI Express Gen 1/2/3/4
- · Display Port

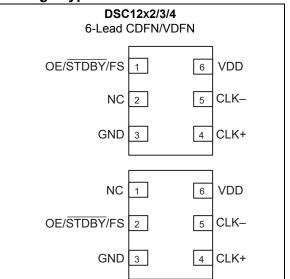
#### **General Description**

The DSC12x2/3/4 family of high performance oscillators utilizes the latest generation of silicon MEMS technology that reduces close-in noise and provides excellent jitter and stability over a wide range of supply voltages and temperatures. By eliminating the need for quartz or SAW technology, MEMS oscillators significantly enhance reliability and accelerate product development, while meeting stringent clock performance criteria for a variety of communications, storage, and networking applications.

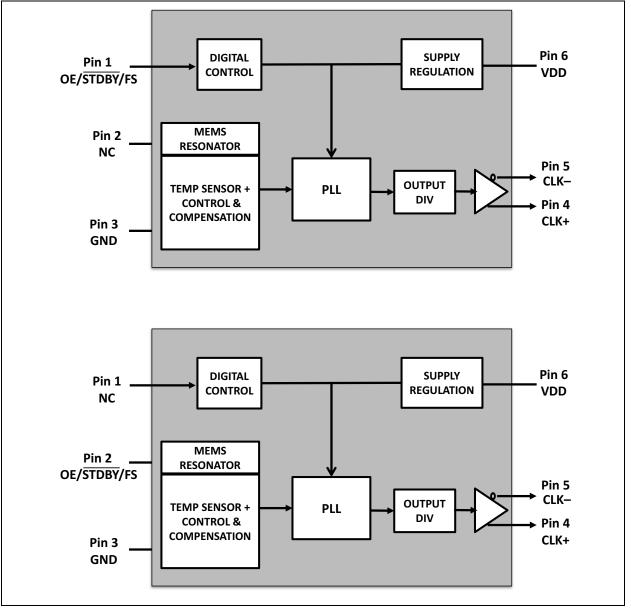
The DSC12x2/3/4 family features a control function on pin 1 or pin 2 that permits either a standby feature (complete power down when STDBY is low), output enable (output is tri-stated with OE low), or a frequency select (choice of two frequencies selected by FS high/low). See the Product Identification System section for detailed information.

All oscillators are available in industry-standard packages, including the small 2.5 mm x 2.0 mm, and are "drop-in" replacements for standard 6-pin LVPECL/LVDS/HCSL crystal oscillators.

#### Package Types



### **Functional Block Diagrams**



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Voltage	
Input Voltage	
ESD Protection (HBM)	20
ESD Protection (MM)	
ESD Protection (CDM)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

**Electrical Characteristics:**  $V_{DD}$  = 2.5V ±10% or 3.3V±10%;  $T_A$  = -40°C to +105°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Supply Voltage	V <sub>DD</sub>	2.25	_	3.63	V	Note 1	
		_	50			LVPECL, f <sub>OUT</sub> = 100 MHz	
			32			LVDS, f <sub>OUT</sub> = 100 MHz	
Supply Current	I <sub>DD</sub>		40		mA	HCSL, f <sub>OUT</sub> = 100 MHz	
		_	23	_		Output disabled (tri-state), f <sub>OUT</sub> = 100 MHz	
Standby Current	I <sub>STDBY_</sub>	_	2.5	5	μA	Input pin = $\overline{\text{STDBY}}$ = Asserted (V <sub>DD</sub> = 3.3V)	
		_		±20		Includes frequency variations due	
Frequency Stability	Δf	_	_	±25	ppm	to initial tolerance, temp., and	
		—	_	±50		power supply voltage	
Startup Time	t <sub>SU</sub>	—	5.5	6	ms	From 90% $V_{DD}$ to valid clock output, T = +25°C, Note 2	
Input Logic Levels	V <sub>IH</sub>	0.75 x V <sub>DD</sub>	_	_	V	Input logic high	
Input Logic Levels	V <sub>IL</sub>	_		0.25 x V <sub>DD</sub>	v	Input logic low	
Output Disable Time	t <sub>DA</sub>	—	_	25	ns	Note 3	
Output Enable Time		—		6	ms	STDBY	
	t <sub>EN</sub>	—		350	ns	OE	
Enable Pull-Up Resistor	_	_	1.5		MΩ	Pull-up resistor on pin 1, Note 4	
LVPECL (DSC12x2)							
Frequency	f <sub>0</sub>	2.5	_	450	MHz	—	
Output Logic Levels	V <sub>OH</sub>	V <sub>DD</sub> – 1.145		—	V	R <sub>L</sub> = 50Ω	
	V <sub>OL</sub>	—	—	V <sub>DD</sub> – 1.695	v		
Peak-to-Peak Output Swing	V <sub>PP</sub>	_	800	_	mV	Single-Ended	
Output Transition Time	t <sub>R</sub>	_	200	250	ne	20% to 80%, $R_1 = 50\Omega$	
	t <sub>F</sub>	—	250	300	ps	20 /0 10 00 /0, NL - 3032	
Output Duty Cycle	SYM	48		52	%	Differential	
Period Jitter RMS	J <sub>PER</sub>	—	2.0	—	ps	f <sub>0</sub> = 156.25 MHz, 10k cycles	

## ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:**  $V_{DD}$  = 2.5V ±10% or 3.3V±10%;  $T_A$  = -40°C to +105°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Period Jitter Peak-to-Peak	J <sub>PTP</sub>		20		ps	f <sub>0</sub> = 156.25 MHz, 10k cycles	
Integrated Phase Noise (Random)	J <sub>PH</sub>	_	0.65	_	ps <sub>RMS</sub>	12 kHz to 20 MHz @156.25 MHz	
LVDS (DSC12x3)							
Frequency	f0	2.3	_	450	MHz	—	
Output Offset Voltage	V <sub>OS</sub>	1.15	1.25	1.35	V	R = 100Ω Differential	
Peak-to-Peak Output Swing	V <sub>PP</sub>	250	350	450	mV	Single-Ended	
Output Transition Time	t <sub>R</sub> t <sub>F</sub>	120	170	220	ps	20% to 80%, $R_L = 100\Omega$	
Output Duty Cycle	SYM	48		52	%	Differential	
Period Jitter RMS	J <sub>PER</sub>	_	2.5		ps	f <sub>0</sub> = 156.25 MHz, 10k cycles	
Period Jitter Peak-to-Peak	J <sub>PTP</sub>	_	20		ps	f <sub>0</sub> = 156.25 MHz, 10k cycles	
Integrated Phase Noise (Random)	J <sub>PH</sub>	_	0.65	_	ps <sub>RMS</sub>	12 kHz to 20 MHz @156.25 MHz	
Period Jitter RMS	J <sub>PER</sub>	_	3		ps	f <sub>0</sub> = 156.25 MHz, T <sub>A</sub> = -40°C to +125°C	
Period Jitter Peak-to-Peak	J <sub>PTP</sub>	_	25	_	ps	f <sub>0</sub> = 156.25 MHz, T <sub>A</sub> = -40°C to +125°C	
Integrated Phase Noise (Random)	J <sub>PH</sub>	_	0.9	_	ps <sub>RMS</sub>	12 kHz to 20 MHz @156.25 MHz T <sub>A</sub> = -40°C to +125°C	
HCSL (DSC12x4)						·	
Frequency	f <sub>0</sub>	2.3		450	MHz	—	
Output Logic Levels	V <sub>OH</sub> V <sub>OL</sub>	0.64		— 0.1	v	R <sub>L</sub> = 50Ω	
Peak-to-Peak Output Swing	V <sub>PP</sub>		750	_	mV	Single-Ended	
	t <sub>R</sub>	200	260	400			
Output Transition Time	t <sub>F</sub>	250	370	500	ps	20% to 80%, $R_L = 50\Omega$	
Output Duty Cycle	SYM	48		52	%	Differential	
Period Jitter RMS	J <sub>PER</sub>	_	2	—	ps	f <sub>0</sub> = 100.00 MHz, 10k cycles	
Period Jitter Peak-to-Peak	J <sub>PTP</sub>		16		ps	f <sub>0</sub> = 100.00 MHz, 10k cycles	
Integrated Phase Noise (Random)	J <sub>PH</sub>	_	0.65	_	ps <sub>RMS</sub>	12 kHz to 20 MHz @100.00 MHz	

Note 1:  $V_{DD}$  pin should be filtered with a 0.1  $\mu$ F capacitor.

2:  $t_{SU}$  is the time to 100 ppm stable output frequency after V<sub>DD</sub> is applied and outputs are enabled.

3: t<sub>DA</sub>: See the Output Waveforms and the Test Circuits sections for more information.

4: Output is enabled if pad is floated (not connected).

## **TEMPERATURE SPECIFICATIONS (Note 1)**

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature	TJ	—	—	+150	°C	—
Storage Temperature Range	Τ <sub>S</sub>	-55	_	+150	°C	—
Lead Temperature		_	_	+260	°C	Soldering, 40s

## 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

#### TABLE 2-1: DSC120X/1X/2X PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	OE/STDBY/FS	Control pin: Output enable/standby/frequency select.
2	NC	No connect.
3	GND	Power supply ground.
4	CLK+	Clock output +.
5	CLK–	Clock output –.
6	VDD	Power supply.

#### TABLE 2-2: DSC123X/4X/5X PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	NC	No connect.
2	OE/STDBY/FS	Control pin: Output enable/standby/frequency select.
3	GND	Power supply ground.
4	CLK+	Clock output +.
5	CLK–	Clock output –.
6	VDD	Power supply.

### 3.0 TERMINATION SCHEME

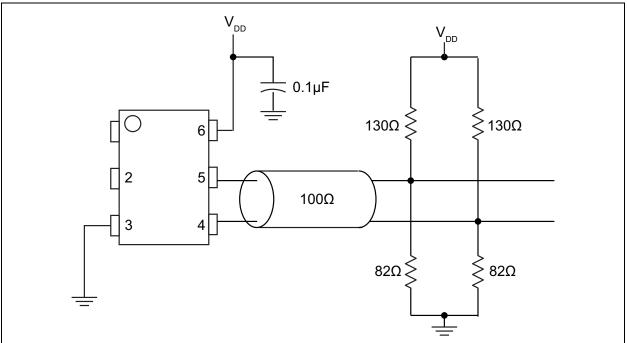
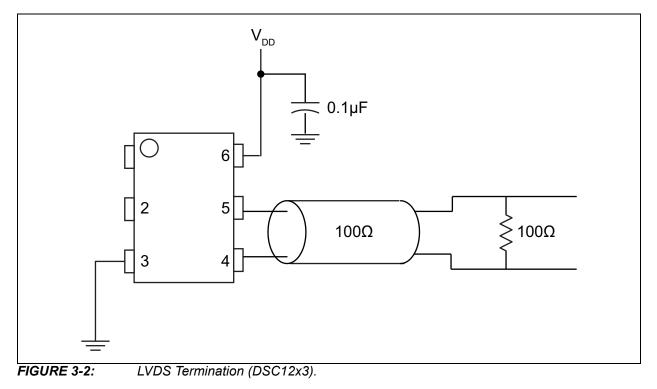


FIGURE 3-1: LVPECL Termination (DSC12x2).

In Figure 3-1, Thevenin termination for 3.3V operation. Values will differ for  $V_{DD}$  = 2.5V.



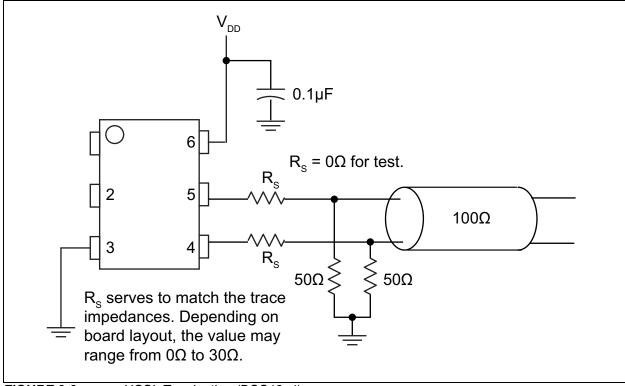
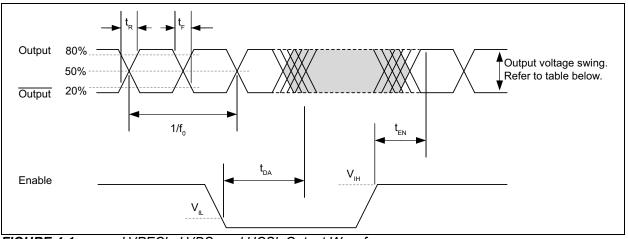


FIGURE 3-3: HCSL Termination (DSC12x4).

### 4.0 OUTPUT WAVEFORM



## FIGURE 4-1: LVPECL, LVDS, and HCSL Output Waveform.

### TABLE 4-1: OUTPUT VOLTAGE SWING BY LOGIC TYPE

Output Logic Protocol	Typical Peak-to-Peak Output Swing
LVPECL	830 mV
LVDS	350 mV
HCSL	675 mV

## 5.0 TEST CIRCUITS

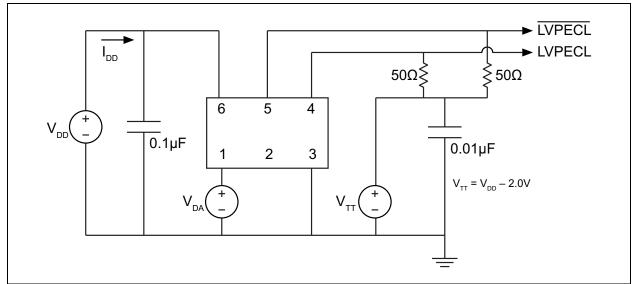


FIGURE 5-1: LVPECL Test Circuit.

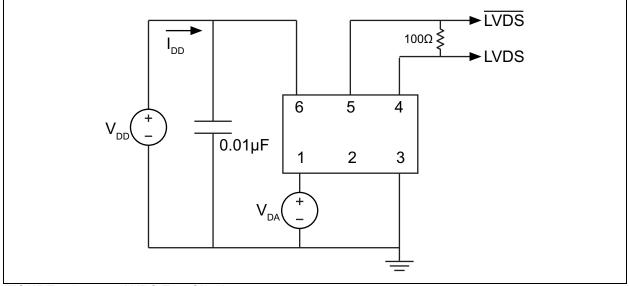


FIGURE 5-2: LVDS Test Circuit.

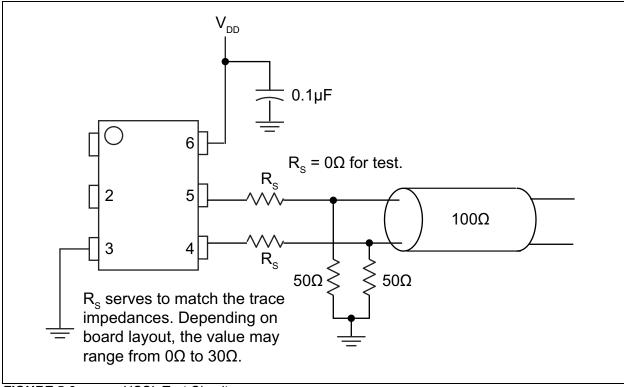
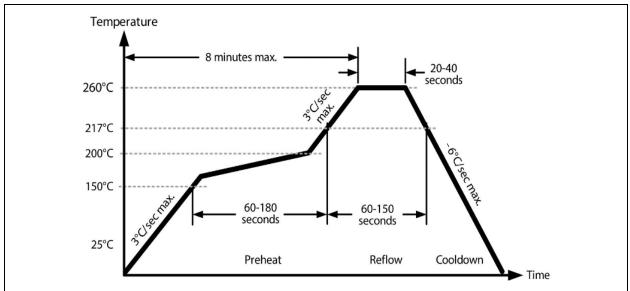


FIGURE 5-3: HCSL Test Circuit.

## 6.0 SOLDER REFLOW PROFILE

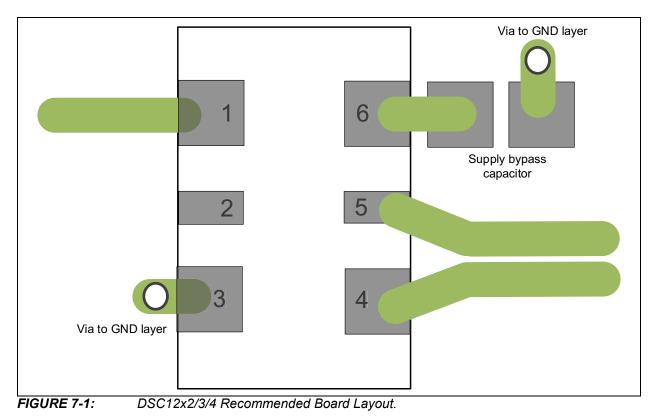


#### FIGURE 6-1: Solder Reflow Profile.

#### TABLE 6-1:SOLDER REFLOW

MSL 1 @ 260°C Refer to JSTD-020C						
Ramp-Up Rate (200°C to Peak Temp.)	3°C/sec. max.					
Preheat Time 150°C to 200°C	60 to 180 sec.					
Time Maintained above 217°C	60 to 150 sec.					
Peak Temperature	255°C to 260°C					
Time within 5°C of Actual Peak	20 to 40 sec.					
Ramp-Down Rate	–6°C/sec. max.					
Time 25°C to Peak Temperature	8 minutes max.					

## 7.0 BOARD LAYOUT (RECOMMENDED)



## 8.0 PHASE NOISE

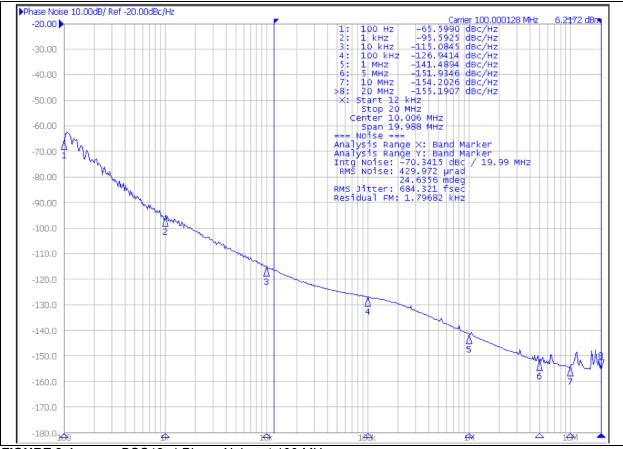


FIGURE 8-1: DSC12x4 Phase Noise at 100 MHz.

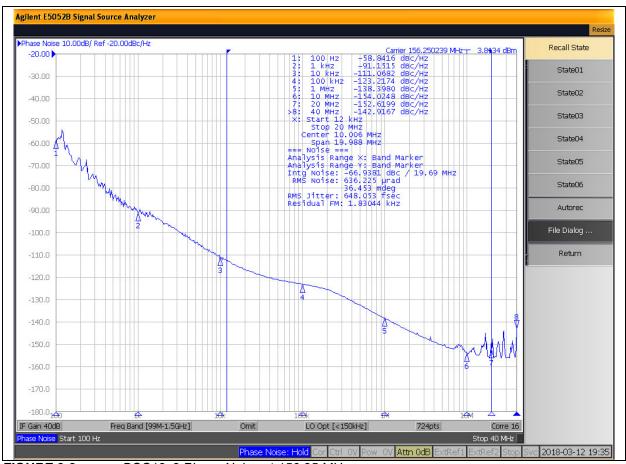
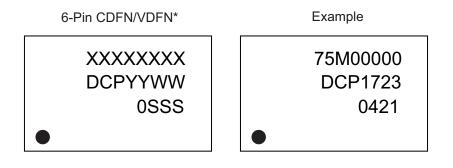


FIGURE 8-2: DSC12x2 Phase Noise at 156.25 MHz.

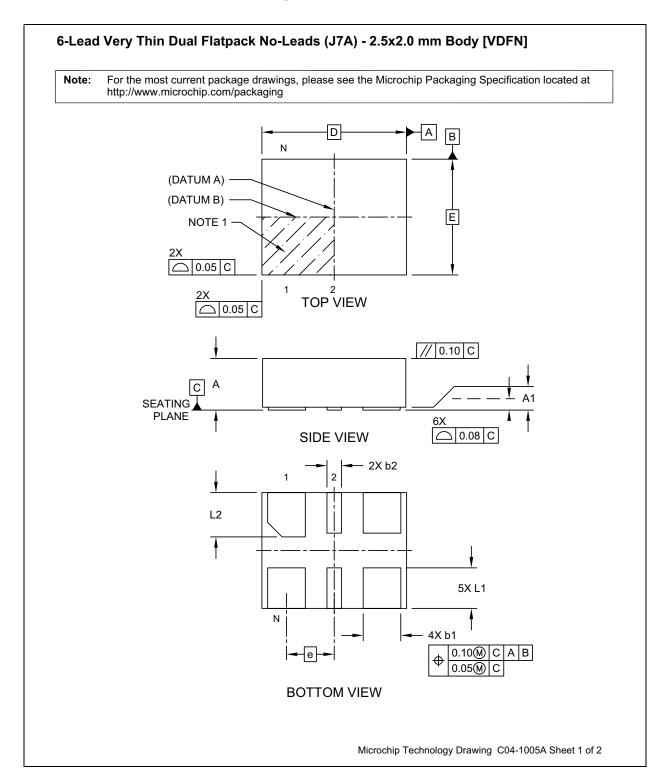
## 9.0 PACKAGING INFORMATION

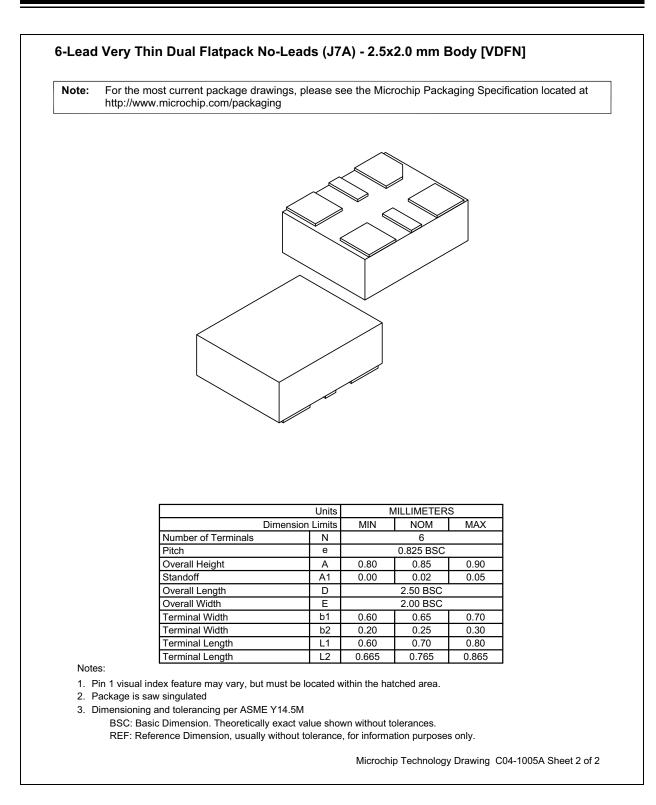
### 9.1 Package Marking Information

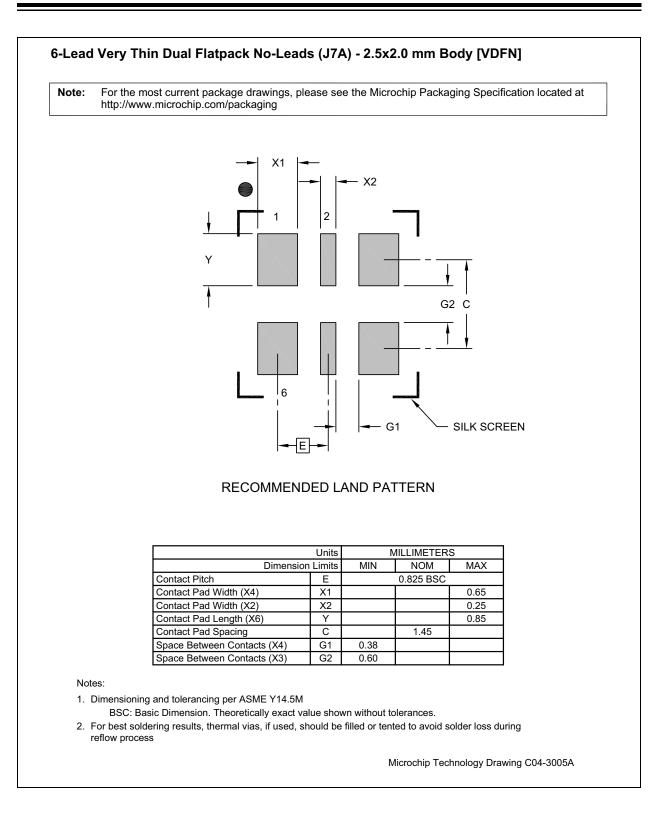


Legend	Y YY WW SSS @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
Note:	be carried	It the full Microchip part number cannot be marked on one line, it will l over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo.
	Underbar	(_) and/or Overbar (⁻) symbol may not be to scale.

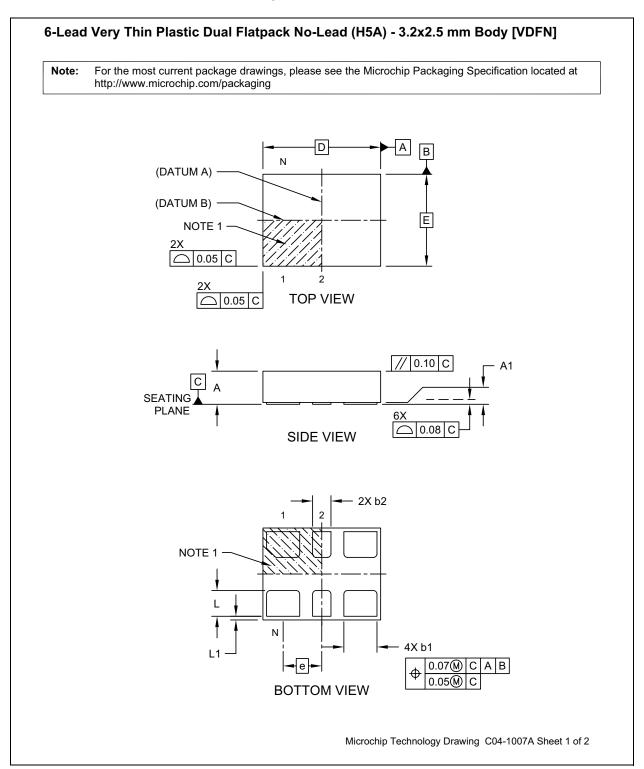
### 6-Lead VDFN 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern

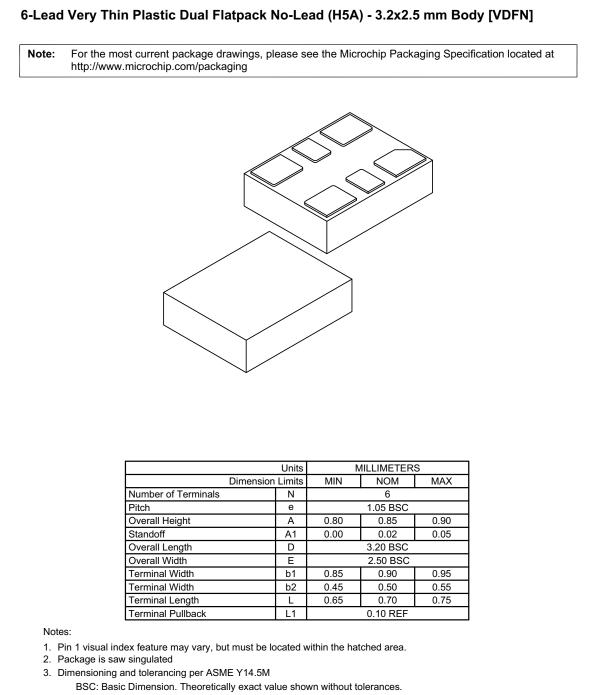






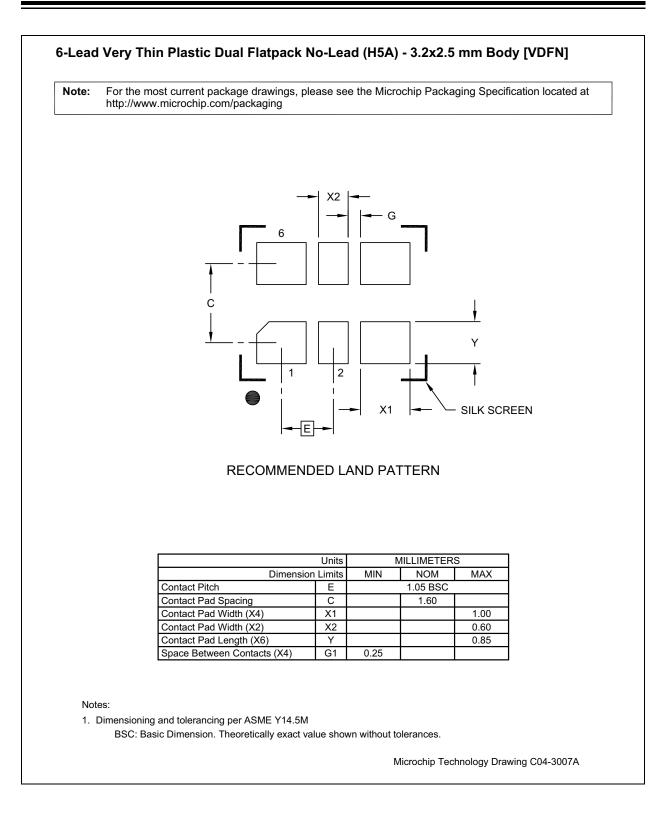
#### 6-Lead VDFN 3.2 mm x 2.5 mm Package Outline and Recommended Land Pattern

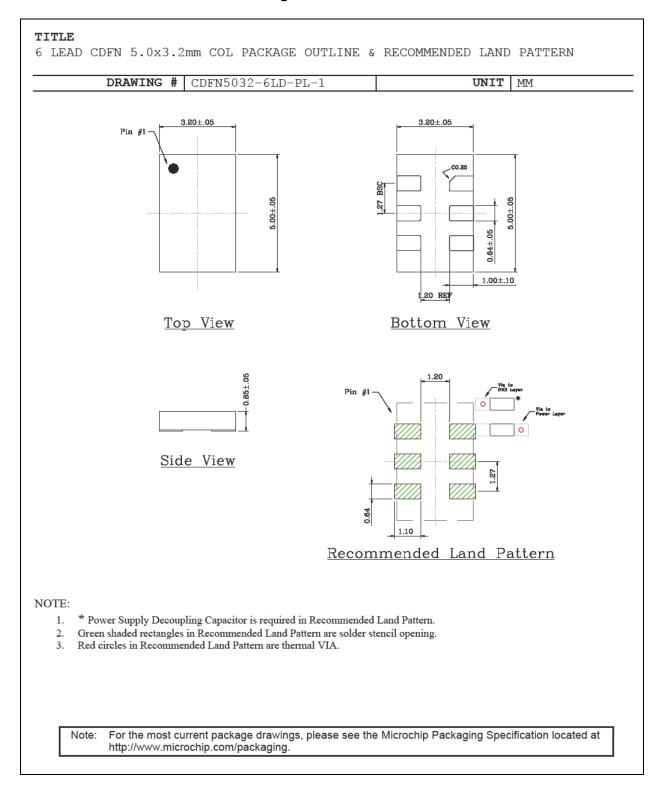




REF: Reference Dimension, usually without tolerance, for information purposes only.

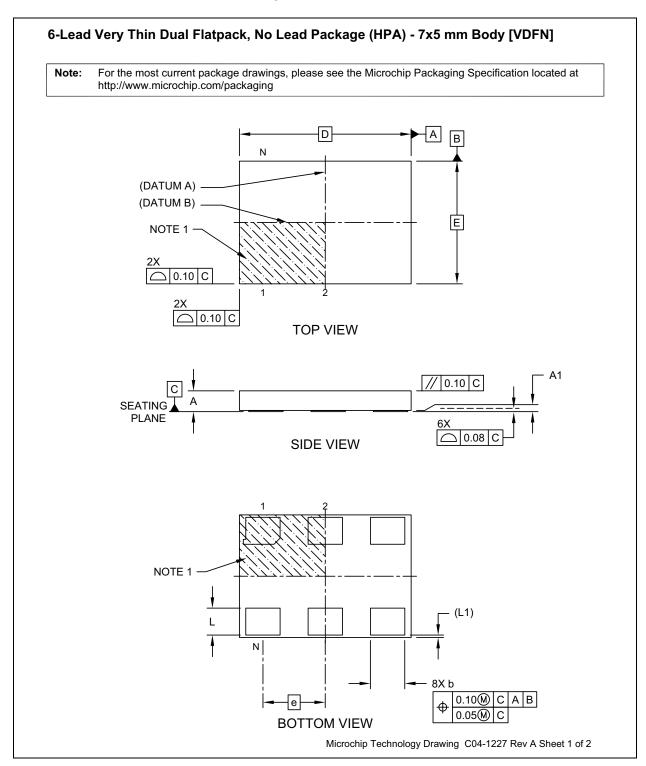
Microchip Technology Drawing C04-1007A Sheet 2 of 2

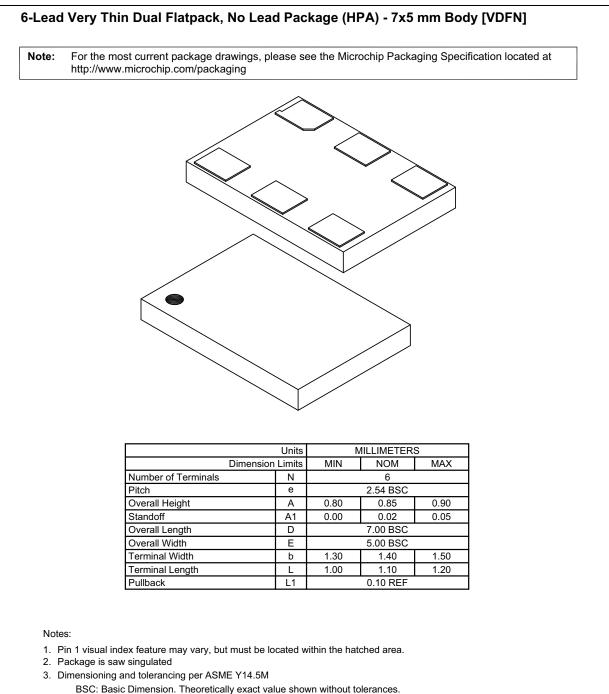




#### 6-Lead CDFN 5.0 mm x 3.2 mm Package Outline and Recommended Land Pattern

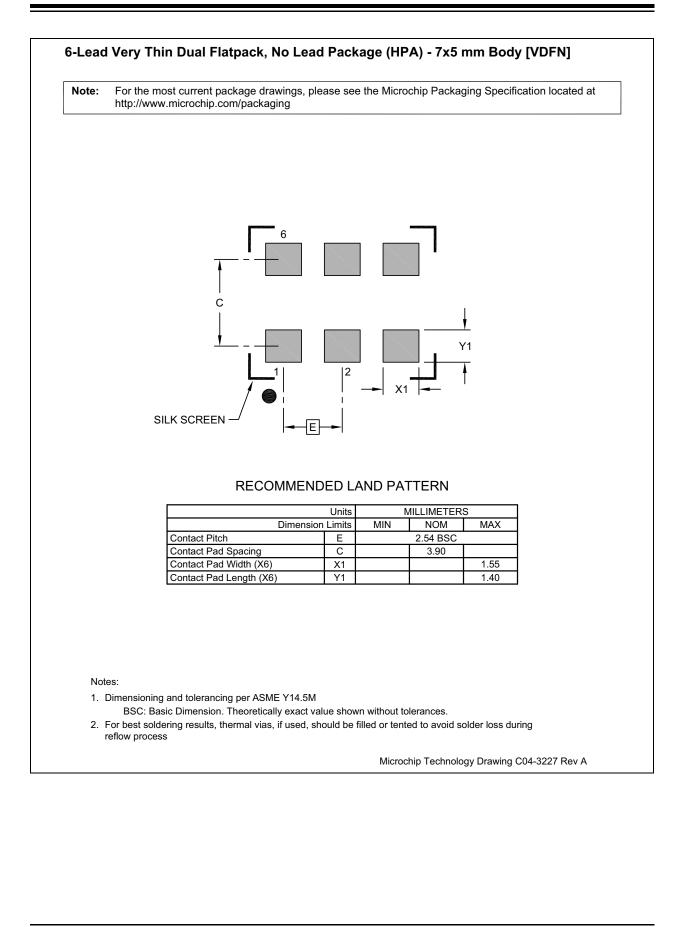
#### 6-Lead VDFN 7.0 mm x 5.0 mm Package Outline and Recommended Land Pattern





REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1227 Rev A Sheet 2 of 2



## APPENDIX A: REVISION HISTORY

## Revision A (April 2019)

• Initial release of DSC12x2/3/4 as Microchip data sheet DS20006011A.

NOTES:

## **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO	<u>). X</u>	¥	¥	¥		¥	<u>-xxxxxxxx</u>	×
Device	Control Pin	Output Format	Package	Temperature	Freq.	Stability	Output Frequency	Media Type
Device:	DSC12:	High Pe Oscillat	rformance Diffe ors	erential MEMS		<b>Example</b> a) DSC12	es: 202NE1-25M00000T: Pi Pull-up, LVPECL Ou	
Control Pin:	$\begin{array}{rrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrr$	Pin 1 Fre Pin 1 <u>OE</u> Pin 2 STI Pin 2 Fre	DBY with Pull-u quency Select v with Pull-up DBY with Pull-u quency Select v with Pull-up	with Pull-up		b) DSC12	Frequency, 1,000/Re 243CL3-C0013: Pin 2 F with Pull-up, LVDS 0	
Output Format:	2 = 3 = 4 =	LVPECL LVDS HCSL				c) DSC12	224BI2-19M50000B: Pir HCSL Output, 5x3.2 ±25 ppm, 19.5 MHz 3,000/Reel	CDFN, -40°C to +85°C,
Package:	N = B = C = D =	5 mm x 3 3.2 mm x	mm 6-Lead VI .2 mm 6-Lead 2.5 mm 6-Lead 2 mm 6-Lead	CDFN d VDFN		d) DSC12	232DL3-55M82000T: Pi Pull-up, LVPECL Ou –40°C to +105°C, ±2 Frequency, 1,000/Re	tput, 2.5x2 VDFN, 0 ppm, 55.82 MHz Output
Temperature:	A = L = I = E =	-40°C to -40°C to -40°C to -20°C to	+105°C +85°C	ble on certain optic	ons)	e) DSC12	213NI1-C0014B: Pin 1 F with Pull-up, LVDS ( -40°C to +85°C, ±50 Frequency, 3,000/Re	Dutput, 7x5 VDFN, ) ppm, Multiple Output
Frequency Stability:	1 = 2 = 3 =	±50 ppm ±25 ppm ±20 ppm				Note 1:	used for ordering purpo	scription. This identifier is oses and is not printed on neck with your Microchip
Output Frequency:	xxMxxxxx	= <100 MH = >100 MH	z z uency Select					
Media Type:	<blank>= T = B =</blank>	Bulk 1,000/Re 3,000/Re						
Please visit the configure the part http://clockworks	t number	for custo	mized frequ					

NOTES:

#### Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

## QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

#### Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KeeLoq, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A. Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, memBrain, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM, net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2019, Microchip Technology Incorporated, All Rights Reserved. ISBN: 978-1-5224-4351-3



## Worldwide Sales and Service

#### AMERICAS

**Corporate Office** 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

#### ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000 China - Chengdu

Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen Tel: 86-592-2388138 China - Zhuhai

Tel: 86-756-3210040

#### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631 India - Pune

Tel: 91-20-4121-0141 Japan - Osaka

Tel: 81-6-6152-7160 Japan - Tokyo

Tel: 81-3-6880- 3770 Korea - Daegu

Tel: 82-53-744-4301 Korea - Seoul

Tel: 82-2-554-7200

Malaysia - Kuala Lumpur

Tel: 60-4-227-8870

Tel: 63-2-634-9065

Taiwan - Hsin Chu Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

Tel: 886-2-2508-8600

Tel: 66-2-694-1351

Tel: 84-28-5448-2100

Tel: 31-416-690399 Fax: 31-416-690340

Italy - Padova

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Tel: 45-4450-2828

Fax: 45-4485-2829

Tel: 358-9-4520-820

Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

Germany - Garching

Tel: 49-2129-3766400

Germany - Heilbronn

Germany - Karlsruhe

Tel: 49-721-625370

Germany - Munich

Tel: 49-89-627-144-0

Fax: 49-89-627-144-44

Germany - Rosenheim

Tel: 49-8031-354-560

Israel - Ra'anana

Italy - Milan

Tel: 972-9-744-7705

Tel: 39-0331-742611

Fax: 39-0331-466781

Tel: 39-049-7625286

**Netherlands - Drunen** 

Tel: 49-7131-67-3636

Tel: 49-8931-9700

Germany - Haan

Finland - Espoo

France - Paris

Fax: 43-7242-2244-393

Denmark - Copenhagen

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

**UK - Wokingham** Tel: 44-118-921-5800 Fax: 44-118-921-5820

Tel: 60-3-7651-7906 Malaysia - Penang

Philippines - Manila

Singapore Tel: 65-6334-8870

Taiwan - Taipei

Thailand - Bangkok

Vietnam - Ho Chi Minh